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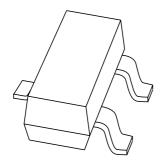
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Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS5350T 50 V, 3 A PNP low V_{CEsat} (BISS) transistor

Product data sheet Supersedes data of 2002 Aug 08 2004 Jan 13



50 V, 3 A PNP low V_{CEsat} (BISS) transistor

PBSS5350T

FEATURES

- Low collector-emitter saturation voltage V_{CEsat} and corresponding low R_{CEsat}
- · High collector current capability
- · High collector current gain
- Improved efficiency due to reduced heat generation.

APPLICATIONS

- · Power management applications
- Low and medium power DC/DC convertors
- · Supply line switching
- · Battery chargers
- Linear voltage regulation with low voltage drop-out (LDO).

DESCRIPTION

PNP low V_{CEsat} transistor in a SOT23 plastic package. NPN complement: PBSS4350T.

MARKING

TYPE NUMBER	MARKING CODE(1)
PBSS5350T	ZD*

Note

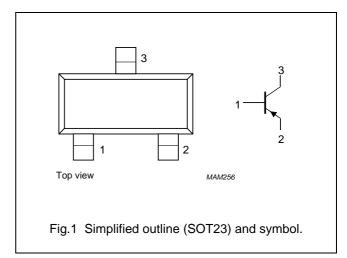
- 1. * = p: Made in Hong Kong.
 - * = t: Made in Malaysia.
 - * = W: Made in China.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	-50	V
I _C	collector current (DC)	-2	Α
I _{CRP}	repetitive peak collector current	-3	Α
R _{CEsat}	equivalent on-resistance	135	mΩ

PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



ORDERING INFORMATION

TYPENUMBER	PACKAGE			
TIFENOMBER	NAME	NAME DESCRIPTION VERSION		
PBSS5350T	_	plastic surface mounted package; 3 leads	SOT23	

50 V, 3 A PNP low V_{CEsat} (BISS) transistor

PBSS5350T

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT	
V _{CBO}	collector-base voltage	open emitter	_	-50	V	
V_{CEO}	collector-emitter voltage	open base	_	-50	V	
V _{EBO}	emitter-base voltage	open collector	_	-5	V	
I _C	collector current (DC)		_	-2	Α	
I _{CRP}	repetitive peak collector current	note 1	_	-3	Α	
I _{CM}	peak collector current	single peak	_	-5	Α	
I _B	base current (DC)		_	-0.5	Α	
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 2	_	300	mW	
		T _{amb} ≤ 25 °C; note 3	_	480	mW	
		T _{amb} ≤ 25 °C; note 4	_	540	mW	
		T _{amb} ≤ 25 °C; notes 1 and 2	-	1.2	W	
T _{stg}	storage temperature		-65	+150	°C	
Tj	junction temperature		_	150	°C	
T _{amb}	operating ambient temperature		-65	+150	°C	

Notes

- 1. Operated under pulsed conditions: pulse width $t_p \le 100$ ms; duty cycle $\delta \le 0.25$.
- 2. Device mounted on a printed-circuit board; single sided copper; tinplated; standard footprint.
- 3. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm².
- 4. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 6 cm².

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th (j-a)}	thermal resistance from junction to	in free air; note 1	417	K/W
	ambient	in free air; note 2	260	K/W
		in free air; note 3	230	K/W
		in free air; notes 1 and 4	104	K/W

Notes

- Device mounted on a printed-circuit board; single sided copper; tinplated; standard footprint.
- 2. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm².
- Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 6 cm².
- 4. Operated under pulsed conditions: pulse width $t_p \leq$ 100 ms; duty cycle $\delta \leq$ 0.25.

50 V, 3 A PNP low V_{CEsat} (BISS) transistor

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CHARACTERISTICS

 T_{amb} = 25 $^{\circ}C$ unless otherwise specified.

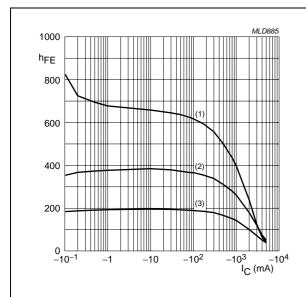
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -50 \text{ V; } I_E = 0$	_	_	-100	nA
		$V_{CB} = -50 \text{ V}; I_E = 0; T_j = 150 \text{ °C}$	_	_	-50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0$	_	_	-100	nA
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}$	200	_	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -500 \text{ mA}$	200	_	_	
		$V_{CE} = -2 \text{ V; } I_{C} = -1 \text{ A; note 1}$	200	_	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -2 \text{ A}; \text{ note 1}$	130	_	_	
		$V_{CE} = -2 \text{ V; } I_{C} = -3 \text{ A; note 1}$	80	_	_	
V _{CEsat}	collector-emitter saturation	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	_	_	-90	mV
	voltage	$I_C = -1 \text{ A}; I_B = -50 \text{ mA}$	_	_	-180	mV
	$I_C = -2 \text{ A}$; $I_B = -100 \text{ mA}$; note 1	_	_	-320	mV	
		$I_C = -2 \text{ A}$; $I_B = -200 \text{ mA}$; note 1	_	_	-270	mV
		$I_C = -3 \text{ A}$; $I_B = -300 \text{ mA}$; note 1	_	_	-390	mV
R _{CEsat}	equivalent on-resistance	$I_C = -2 \text{ A}$; $I_B = -200 \text{ mA}$; note 1	_	90	135	mΩ
V _{BEsat}	base-emitter saturation	$I_C = -2 \text{ A}$; $I_B = -100 \text{ mA}$; note 1	_	_	-1.1	V
	voltage	$I_C = -3 \text{ A}$; $I_B = -300 \text{ mA}$; note 1	_	_	-1.2	V
V _{BEon}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V; } I_{C} = -1 \text{ A; note 1}$	-1.2	_	_	V
f _T	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz	100	_	_	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	_	_	35	pF

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

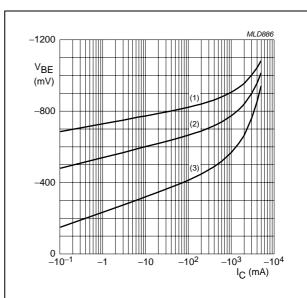
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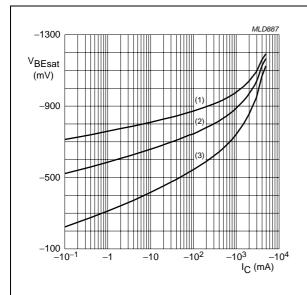
- $V_{CE} = -2 \text{ V}.$ (1) $T_{amb} = 150 \text{ }^{\circ}\text{C}.$
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.2 DC current gain as a function of collector current; typical values.



- $V_{CE} = -2 \text{ V}.$ (1) $T_{amb} = -55 \text{ }^{\circ}\text{C}.$
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

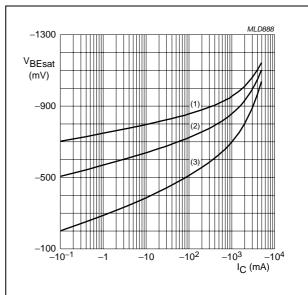
Fig.3 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B}=10.$

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.4 Base-emitter saturation voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 20$.

- (1) $T_{amb} = -55 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

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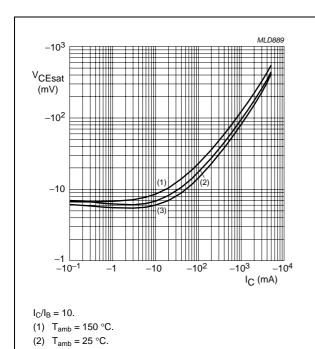
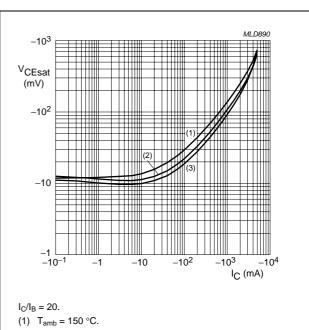
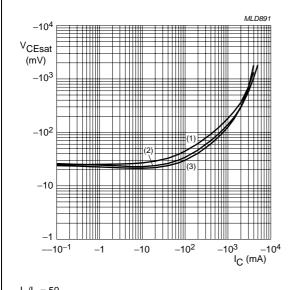


Fig.6 Collector-emitter saturation voltage as a function of collector current; typical values.



- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.7 Collector-emitter saturation voltage as a function of collector current; typical values.



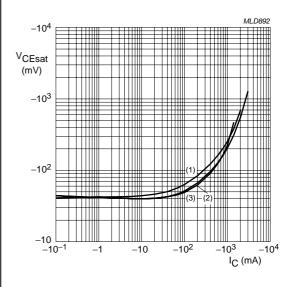
 $I_{\rm C}/I_{\rm B} = 50.$

(1) T_{amb} = 150 °C.

(3) $T_{amb} = -55 \, ^{\circ}C$.

- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.8 Collector-emitter saturation voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 100.$

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.9 Collector-emitter saturation voltage as a function of collector current; typical values.

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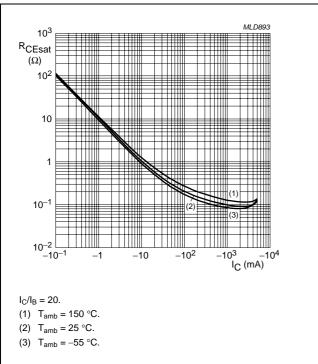


Fig.10 Equivalent on-resistance as a function of collector current; typical values.

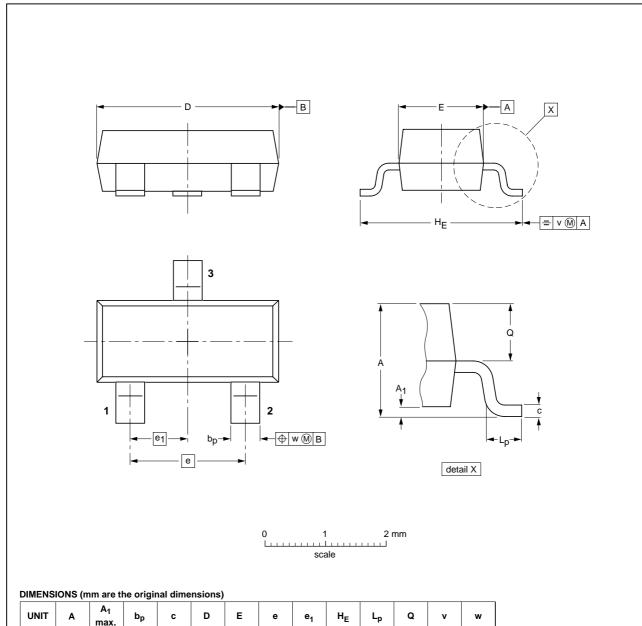
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PACKAGE OUTLINE



SOT23



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT23		TO-236AB				04-11-04 06-03-16

1.9

0.45

0.55

0.1

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max

0.9

0.48

0.38

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DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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NXP Semiconductors

Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

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